

Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	230	W	8/20µs, Per in Figure 3
Peak Pulse Current	I _{PP}	5	Α	8/20µs, Per in Figure 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD_Air}	±30	kV	Standard IEC 61000-4-2
ESD Protection – Human Body Model	V _{ESD_HBM}	±16	kV	MIL-STD-883
Electrical Fast Transient Current	I _{EFT}	80	Α	Standard IEC 61000-4-4(EFT)

Thermal Characteristics

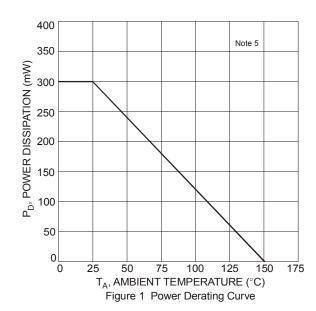
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	300	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	417	°C/W
Operating Junction Temperature Range	T_J	-65 to +150	°C
Storage Temperature Range	T _{STG}	-65 to +150	°C

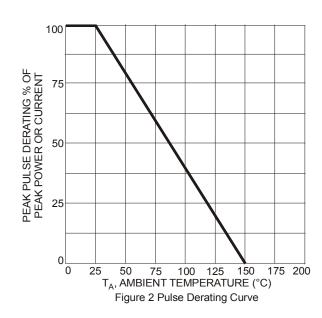
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V_{RWM}	_	_	24	V	_
Breakdown Voltage	V_{BR}	26	_	32	V	I _R = 1.0mA
Reverse Leakage Current (Note 6)	I _R	_	_	10	nA	V _{RWM} = 24V
Clamping Voltage (Note 7)	VcL	_	_	34	V	$I_{PP} = 1A, t_p = 8/20 \mu s$
		_	_	41	V	$I_{PP} = 5A$, $t_p = 8/20 \mu s$
Differential Resistance	R _{DIF}	_	1	_	Ω	$I_R = 1.0A$, $t_p = 8/20 \mu s$
Channel Input Capacitance	Ст	_	42	52	pF	V _{IN} = 0V, f = 1MHz, Pin 1 or Pin 2 to Pin 3
		_	21	28	pF	V _{IN} = 0V, f = 1MHz, between Pin 1 and Pin 2

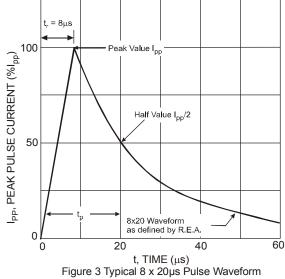
Notes:

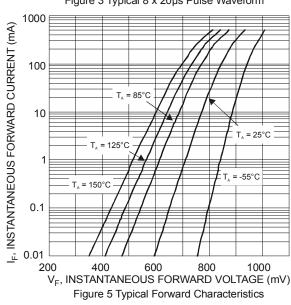
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Measured from pin 1 or pin 2 to pin 3; Non-repetitive current pulse per Figure 1.











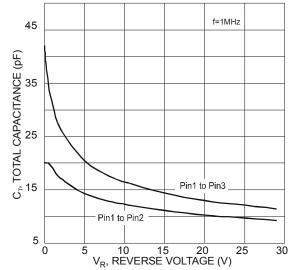
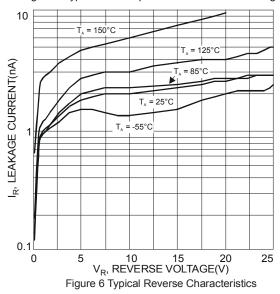
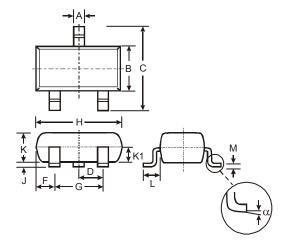


Figure 4 Typical Total Capacitance vs. Reverse Voltage



Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

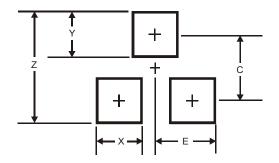


SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
C	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.903	1.10	1.00		
K1	-	-	0.400		
L	0.45	0.61	0.55		
М	0.085	0.18	0.11		
α	0°	8°	-		
All Dimensions in mm					



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Υ	0.9
С	2.0
E	1.35

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